## **NUP4000**

## Bi-directional TVS Array for High-Speed Data Line Protection

The NUP4000 transient voltage suppressor is designed to protect equipment attached to up to four high speed communication lines from ESD, EFT, and lightning.

### Features:

- SO-8 Package
- Peak Power 400 W 8 x 20 uS
- ESD Rating:

IEC 61000-4-2 (ESD) ±15 kV (air) ±8 kV (contact)

IEC 61000-4-4 (EFT) 40 A (5/50 ns)

IEC 61000–4–5 (lightning) 12 A (8/20 μs)

- UL Flammability Rating of 94 V-0
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

## **Typical Applications:**

- High Speed Communication Line Protection
- 15 V Data and I/O Lines
- Microprocessor Based Equipment
- LAN/WAN Equipment
- Servers
- Notebook and Desktop PC
- Serial and Parallel Ports
- Peripherals

## **MAXIMUM RATINGS**

| Rating   | Symbol                            | Value          | Unit |
|--|-----------------------------------|----------------|------|
| Peak Power Dissipation<br>8 x 20 μs @ T <sub>A</sub> = 25°C (Note 1) | P <sub>pk</sub>                   | 400            | W    |
| Peak Pulse Current<br>8 x 20 μs @ T <sub>A</sub> = 25°C (Note 1)     | I <sub>PP</sub>                   | 10             | Α    |
| Junction and Storage<br>Temperature Range                            | T <sub>J</sub> , T <sub>stg</sub> | -55 to<br>+150 | °C   |
| Lead Solder Temperature –<br>Maximum 10 Seconds Duration             | TL                                | 260            | °C   |

<sup>1.</sup> Non-repetitive current pulse 8 x 20 μS exponential decay waveform

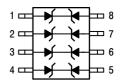


## ON Semiconductor®

http://onsemi.com

## SO-8 VOLTAGE SUPPRESSOR 400 WATTS PEAK POWER 15 VOLTS

# PIN CONFIGURATION AND SCHEMATIC





SO-8 CASE 751

## **MARKING DIAGRAM**



A = Assembly Location Y = Year

WW = Work Week ■ Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

| Device      | Package           | Shipping <sup>†</sup> |
|-------------|-------------------|-----------------------|
| NUP4000DR2G | SO-8<br>(Pb-Free) | 2500 / Tape & Reel    |

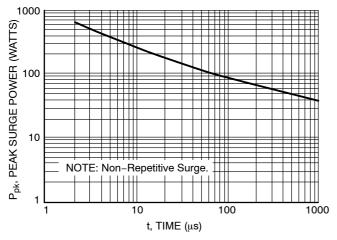
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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## **NUP4000**

## **ELECTRICAL CHARACTERISTICS**

| Characteristic  | Symbol          | Min  | Тур | Max | Unit |
|---|-----------------|------|-----|-----|------|
| Reverse Working Voltage                                       | $V_{RWM}$       | -    | -   | 15  | V    |
| Reverse Breakdown Voltage @ I <sub>t</sub> = 1.0 mA           | V <sub>BR</sub> | 16.7 | -   | -   | V    |
| Reverse Leakage Current @ V <sub>RWM</sub> = 15 Volts         | I <sub>R</sub>  | N/A  | -   | 1.0 | μА   |
| Maximum Clamping Voltage @ I <sub>PP</sub> = 1.0 A, 8 x 20 μS | V <sub>C</sub>  | N/A  | -   | 24  | V    |
| Maximum Clamping Voltage @ I <sub>PP</sub> = 5.0 A, 8 x 20 μS | V <sub>C</sub>  | N/A  | -   | 30  | V    |
| Maximum Peak Pulse Current                                    | I <sub>PP</sub> | =    | -   | 10  | Α    |
| Junction Capacitance @ V <sub>R</sub> = 0 V, f = 1 MHz        | CJ              | -    | -   | 75  | pF   |



PEAK VALUE I<sub>RSM</sub> @ 8 μs PULSE WIDTH (t<sub>P</sub>) IS DEFINED AS THAT POINT WHERE THE % OF PEAK PULSE CURRENT PEAK CURRENT DECAY = 8 μs - HALF VALUE I<sub>RSM</sub>/2 @ 20 μs t, TIME (μs)

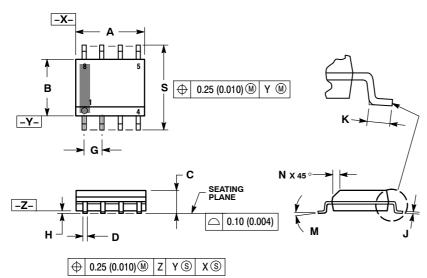
Figure 1. Pulse Width

Figure 2.  $8\times20~\mu s$  Pulse Waveform

## NUP4000

#### PACKAGE DIMENSIONS

## SOIC-8 NB CASE 751-07 **ISSUE AJ**



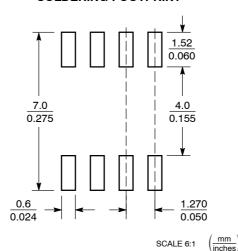
#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- PER SIDE.

  DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

|     | MILLIMETERS |      | INCHES    |       |  |
|-----|-------------|------|-----------|-------|--|
| DIM | MIN         | MAX  | MIN       | MAX   |  |
| Α   | 4.80        | 5.00 | 0.189     | 0.197 |  |
| В   | 3.80        | 4.00 | 0.150     | 0.157 |  |
| С   | 1.35        | 1.75 | 0.053     | 0.069 |  |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |  |
| G   | 1.27 BSC    |      | 0.050 BSC |       |  |
| Н   | 0.10        | 0.25 | 0.004     | 0.010 |  |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |  |
| Κ   | 0.40        | 1.27 | 0.016     | 0.050 |  |
| М   | 0 °         | 8 °  | 0 °       | 8 °   |  |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |  |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |  |

## **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SCALE 6:1

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